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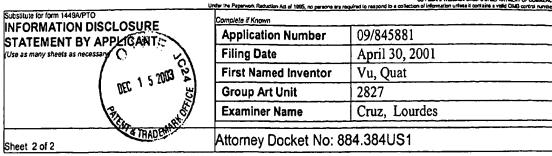
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INFORMATION DISCLOSURE Complete if Known **Application Number** 09/845881 STATEMENT BY APPLICANT, Filing Date April 30, 2001 **First Named Inventor** Vu, Quat DEC 1 5 2003 2827 **Group Art Unit** Cruz, Lourdes **Examiner Name** TRADE Attorney Docket No: 884.384US1 Sheet 1 of 2

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